PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JUI-KANG YEN	09/22/2008
YUNG-WEI CHEN	09/23/2008

RECEIVING PARTY DATA

Name:	SEMI-PHOTONICS CO., LTD.	
Street Address:	7F, NO. 13, KE JUNG RD.	
Internal Address:	CHU-NAN SITE, HSINCHU SCIENCE PARK,	
City:	CHU-NAN, MIAO-LI COUNTY	
State/Country:	TAIWAN	
Postal Code:	350	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29249576

CORRESPONDENCE DATA

Fax Number: (713)623-4846

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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Correspondent Name: B. Todd Patterson/Patterson & Sheridan

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Address Line 4: HOUSTON, TEXAS 770566582

ATTORNEY DOCKET NUMBER:	SEMI/0025
NAME OF SUBMITTER:	RANDOL W. READ

Total Attachments: 2

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PATENT REEL: 021588 FRAME: 0033

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PATENT REEL: 021588 FRAME: 0034

Atty. Dkt. No.: 1672.027312 (SEMI/0025)

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Jul-Kang Yen 8 F, No. 362, Sec. 4, Chengde Rd., Shihlin District, Taipei City 111, Taiwan ROC	2)	YUNG-WEI CHEN 13F-5, No. 496, Sec. 4, Henan Rd., Nantun District, Taichung City 408, Taiwan ROC
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(hereinafter referred to as Assignors), have invented a certain invention entitled:

LEAD FRAME FOR A FOUR-PIN LIGHT-EMITTING DIODE DEVICE

enclosed herewith or for which application for Letters Patent in the United States was filed on October 12, 2006, under Serial No. 29/249,576, executed on even date herewith; and

WHEREAS, Semi-Photonics Co., Ltd., a corporation of Taiwan, having a place of business at 7F, No. 13, Ke Jung Rd., Chu-Nan Site, Hsinchu Science Park, Chu-Nan 350, Miao-Li County, Taiwan, R.O.C. (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

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- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting conventional, substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted including without limitation opposition proceedings, cancellation thereon. proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.
- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	Sopt. 22, 2018 (DATE)	Jui-Kang Ven
,	7	JUI-KANG VEN

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RECORDED: 09/25/2008